

FEATURES

- Single Supply or Dual Supplies
- Wide Range of Supply Voltage:
 - Max Rating . . . 2 V to 36 V
 - Tested to 30 V . . . Non-V Devices
 - Tested to 32 V . . . V-Suffix Devices
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ
- Low Input Bias Current . . . 25 nA Typ
- Low Input Offset Current . . . 3 nA Typ (LM139)
- Low Input Offset Voltage . . . 2 mV Typ
- Common-Mode Input Voltage Range Includes Ground
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . ± 36 V
- Low Output Saturation Voltage
- Output Compatible With TTL, MOS, and CMOS

DESCRIPTION/ORDERING INFORMATION

These devices consist of four independent voltage comparators that are designed to operate from a single power supply over a wide range of voltages. Operation from dual supplies also is possible, as long as the difference between the two supplies is 2 V to 36 V, and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. Current drain is independent of the supply voltage. The outputs can be connected to other open-collector outputs to achieve wired-AND relationships.

The LM139 and LM139A are characterized for operation over the full military temperature range of -55°C to 125°C . The LM239 and LM239A are characterized for operation from -25°C to 125°C . The LM339 and LM339A are characterized for operation from 0°C to 70°C . The LM2901, LM2901AV, and LM2901V are characterized for operation from -40°C to 125°C .

LM139, LM139A . . . D, J, OR W PACKAGE

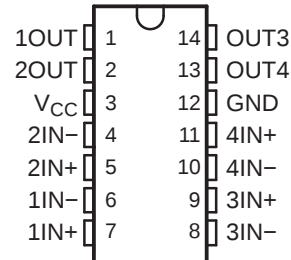
LM239 . . . D, N, OR PW PACKAGE

LM239A . . . D PACKAGE

LM339, LM339A . . . D, DB, N, NS, OR PW PACKAGE

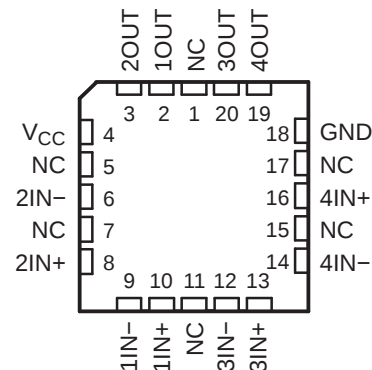
LM2901 . . . D, N, NS, OR PW PACKAGE

(TOP VIEW)



LM139, LM139A . . . FK PACKAGE

(TOP VIEW)



NC – No internal connection



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**LM139, LM139A, LM239, LM239A
LM339, LM339A, LM2901, LM2901AV, LM2901V
QUAD DIFFERENTIAL COMPARATORS**

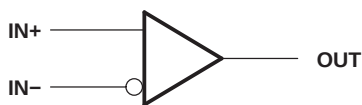
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ORDERING INFORMATION

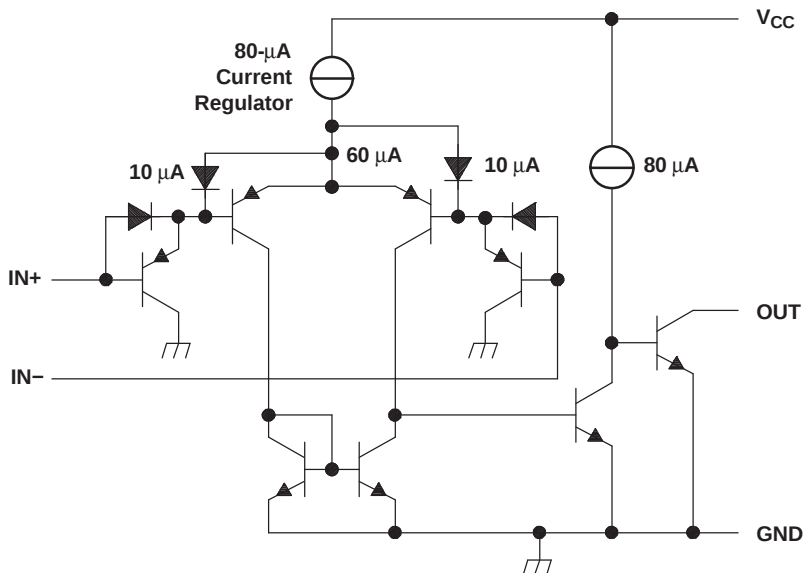
T_A	$V_{IO,max}$ AT 25°C	MAX V_{CC}	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	5 mV	30 V	PDIP – N	Tube of 25	LM339N	LM339N
			SOIC – D	Tube of 50	LM339D	LM339
				Reel of 2500	LM339DR	
			SOP – NS	Reel of 2000	LM339NSR	LM339
			SSOP – DB	Reel of 2000	LM339DBR	LM339
			TSSOP – PW	Tube of 90	LM339PW	L339
				Reel of 2000	LM339PWR	
	2 mV	30 V	PDIP – N	Tube of 25	LM339AN	LM339AN
			SOIC – D	Tube of 50	LM339AD	LM339A
				Reel of 2500	LM339ADR	
			SOP – NS	Reel of 2000	LM339ANSR	LM339A
			SSOP – DB	Reel of 2000	LM339ADBR	L339A
			TSSOP – PW	Tube of 90	LM339APW	L339A
				Reel of 2000	LM339APWR	
–25°C to 85°C	5 mV	30 V	PDIP – N	Tube of 25	LM239N	LM239N
			SOIC – D	Tube of 50	LM239D	LM239
				Reel of 2500	LM239DR	
			TSSOP – PW	Tube of 90	LM239PW	L239
				Reel of 2000	LM239PWR	
	2 mV	30 V	SOIC – D	Tube of 50	LM239AD	LM239A
				Reel of 2500	LM239ADR	
–40°C to 125°C	7 mV	30 V	PDIP – N	Tube of 25	LM2901N	LM2901N
			SOIC – D	Tube of 50	LM2901D	LM2901
				Reel of 2500	LM2901DR	
			SOP – NS	Reel of 2000	LM2901NSR	LM2901
			TSSOP – PW	Tube of 90	LM2901PW	L2901
				Reel of 2000	LM2901PWR	
	7 mV	32 V	SOIC – D	Reel of 2500	LM2901VQDR	L2901V
			TSSOP – PW	Reel of 2000	LM2901VQPWR	L2901V
	2 mV	32 V	SOIC – D	Reel of 2500	LM2901AVQDR	L2901AV
			TSSOP – PW	Reel of 2000	LM2901AVQPWR	L2901AV
–55°C to 125°C	5 mV	30 V	CFP – W	Tube of 25	LM139W	LM139W
			CDIP – J	Tube of 25	LM139J	LM139J
			LCCC – FK	Tube of 55	LM139FK	LM139FK
			SOIC – D	Tube of 50	LM139D	LM139D
				Reel of 2500	LM139DR	
	2 mV	30 V	CFP – W	Tube of 25	LM139AW	LM139AW
			CDIP – J	Tube of 25	LM139AJ	LM139AJ
			LCCC – FK	Tube of 55	LM139AFK	LM139AFK
			SOIC – D	Tube of 50	LM139AD	LM139AD
				Reel of 2500	LM139ADR	

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

SYMBOL (EACH COMPARATOR)



SCHEMATIC (EACH COMPARATOR)



All current values shown are nominal.

**LM139, LM139A, LM239, LM239A
LM339, LM339A, LM2901, LM2901AV, LM2901V
QUAD DIFFERENTIAL COMPARATORS**

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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{CC}	Supply voltage ⁽²⁾		36	V
V_{ID}	Differential input voltage ⁽³⁾		± 36	V
V_I	Input voltage range (either input)	-0.3	36	V
V_O	Output voltage		36	V
I_O	Output current		20	mA
	Duration of output short circuit to ground ⁽⁴⁾			Unlimited
θ_{JA}	Package thermal impedance ⁽⁵⁾⁽⁶⁾	D package	86	$^{\circ}\text{C/W}$
		DB package	96	
		N package	80	
		NS package	76	
		PW package	113	
θ_{JC}	Package thermal impedance ⁽⁷⁾⁽⁸⁾	FK package	5.61	$^{\circ}\text{C/W}$
		J package	15.05	
		W package	14.65	
T_J	Operating virtual junction temperature		150	$^{\circ}\text{C}$
	Case temperature for 60 s	FK package	260	$^{\circ}\text{C}$
	Lead temperature 1,6 mm (1/16 in) from case for 60 s	J package	300	$^{\circ}\text{C}$
T_{stg}	Storage temperature range	-65	150	$^{\circ}\text{C}$

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential voltages, are with respect to network ground.
- (3) Differential voltages are at IN+ with respect to IN-.
- (4) Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.
- (5) Maximum power dissipation is a function of T_J (max), θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150 $^{\circ}\text{C}$ can affect reliability.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.
- (7) Maximum power dissipation is a function of T_J (max), θ_{JC} , and T_C . The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_J(\text{max}) - T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150 $^{\circ}\text{C}$ can affect reliability.
- (8) The package thermal impedance is calculated in accordance with MIL-STD-883.

Electrical Characteristics

at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS ⁽¹⁾		T _A ⁽²⁾	LM139			LM139A			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
V _{IO}	Input offset voltage	V _{CC} = 5 V to 30 V, V _{IC} = V _{ICR} min, V _O = 1.4 V		25°C	2	5		1	2		mV
				Full range		9			4		
I _{IO}	Input offset current	V _O = 1.4 V		25°C	3	25		3	25		nA
				Full range		100			100		
I _{IB}	Input bias current	V _O = 1.4 V		25°C	–25	–100		–25	–100		nA
				Full range		–300			–300		
V _{ICR}	Common-mode input-voltage range			25°C	0 to V _{CC} – 1.5			0 to V _{CC} – 1.5			V
				Full range	0 to V _{CC} – 2			0 to V _{CC} – 2			
A _{VD}	Large-signal differential-voltage amplification	V _{CC+} = ±7.5 V, V _O = –5 V to 5 V		25°C	200			50	200		V/mV
I _{OH}	High-level output current	V _{ID} = 1 V	V _{OH} = 5 V	25°C	0.1			0.1			nA
			V _{OH} = 30 V	Full range	1			1			μA
V _{OL}	Low-level output voltage	V _{ID} = –1 V, I _{OL} = 4 mA		25°C	150	400		150	400		mV
				Full range	700			700			
I _{OL}	Low-level output current	V _{ID} = –1 V,	V _{OL} = 1.5 V	25°C	6	16		6	16		mA
I _{CC}	Supply current (four comparators)	V _O = 2.5 V,	No load	25°C	0.8	2		0.8	2		mA

(1) All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

(2) Full range (MIN to MAX) for LM139 and LM139A is –55°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

Switching Characteristics

$V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS		LM139 LM139A	UNIT
			TYP	
Response time	R _L connected to 5 V through 5.1 kΩ, C _L = 15 pF ⁽¹⁾⁽²⁾	100-mV input step with 5-mV overdrive	1.3	μs
		TTL-level input step	0.3	

(1) C_L includes probe and jig capacitance.

(2) The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

LM139, LM139A, LM239, LM239A LM339, LM339A, LM2901, LM2901AV, LM2901V QUAD DIFFERENTIAL COMPARATORS

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Electrical Characteristics

at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS ⁽¹⁾		T _A ⁽²⁾	LM239 LM339		LM239A LM339A		UNIT	
					MIN	TYP	MAX	MIN		TYP
V _{IO}	Input offset voltage	V _{CC} = 5 V to 30 V, V _{IC} = V _{ICR} min, V _O = 1.4 V		25°C	2	5		1	3	mV
				Full range			9			
I _{IO}	Input offset current	V _O = 1.4 V		25°C	5	50		5	50	nA
				Full range			150			
I _{IB}	Input bias current	V _O = 1.4 V		25°C	–25	–250		–25	–250	nA
				Full range			–400			
V _{ICR}	Common-mode input-voltage range			25°C	0 to V _{CC} – 1.5		0 to V _{CC} – 1.5		V	
				Full range	0 to V _{CC} – 2		0 to V _{CC} – 2			
A _{VD}	Large-signal differential-voltage amplification	V _{CC} = 15 V, V _O = 1.4 V to 11.4 V, R _L ≥ 15 kΩ to V _{CC}		25°C	50	200	50	200	V/mV	
I _{OH}	High-level output current	V _{ID} = 1 V	V _{OH} = 5 V	25°C	0.1	50	0.1	50	nA	
			V _{OH} = 30 V	Full range		1		1	μA	
V _{OL}	Low-level output voltage	V _{ID} = –1 V, I _{OL} = 4 mA	25°C	150	400	150	400	mV		
			Full range		700		700			
I _{OL}	Low-level output current	V _{ID} = –1 V, V _{OL} = 1.5 V	25°C	6	16	6	16	mA		
I _{CC}	Supply current (four comparators)	V _O = 2.5 V, No load	25°C	0.8	2	0.8	2	mA		

(1) All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

(2) Full range (MIN to MAX) for LM239/LM239A is –25°C to 85°C, and for LM339/LM339A is 0°C to 70°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

Switching Characteristics

$V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS		LM239 LM239A LM339 LM339A	UNIT
			TYP	
Response time	R _L connected to 5 V through 5.1 kΩ, C _L = 15 pF ⁽¹⁾⁽²⁾	100-mV input step with 5-mV overdrive	1.3	μs
		TTL-level input step	0.3	

(1) C_L includes probe and jig capacitance.

(2) The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

Electrical Characteristics

at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS ⁽¹⁾		T _A ⁽²⁾	LM2901			UNIT
					MIN	TYP	MAX	
V _{IO} Input offset voltage	V _{IC} = V _{ICR} min, V _O = 1.4 V, V _{CC} = 5 V to MAX ⁽³⁾	Non-A devices	25°C	2		7	mV	
			Full range	15				
		A-suffix devices	25°C	1		2		
			Full range	4				
I _{IO} Input offset current	V _O = 1.4 V		25°C	5		50	nA	
			Full range	200				
I _{IB} Input bias current	V _O = 1.4 V		25°C	–25		–250	nA	
			Full range	–500				
V _{ICR} Common-mode input-voltage range			25°C	0 to V _{CC} – 1.5		V		
			Full range	0 to V _{CC} – 2				
A _{VD} Large-signal differential-voltage amplification	V _{CC} = 15 V, V _O = 1.4 V to 11.4 V, R _L ≥ 15 kΩ to V _{CC}		25°C	25		100	V/mV	
I _{OH} High-level output current	V _{ID} = 1 V	V _{OH} = 5 V	25°C	0.1		50	nA	
		V _{OH} = V _{CC} MAX ⁽³⁾	Full range	1		μA		
V _{OL} Low-level output voltage	V _{ID} = –1 V, I _{OL} = 4 mA	Non-V devices	25°C	150		500	mV	
		V-suffix devices		150		400		
		All devices	Full range	700				
I _{OL} Low-level output current	V _{ID} = –1 V,	V _{OL} = 1.5 V	25°C	6		16	mA	
I _{CC} Supply current (four comparators)	V _O = 2.5 V, No load	V _{CC} = 5 V	25°C	0.8		2	mA	
		V _{CC} = MAX ⁽³⁾		1		2.5		

(1) All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

(2) Full range (MIN to MAX) for LM2901 is –40°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

(3) $V_{CC}\text{ MAX} = 30\text{ V}$ for non-V devices, and 32 V for V-suffix devices

Switching Characteristics

$V_{CC} = 5\text{ V}, T_A = 25^\circ\text{C}$

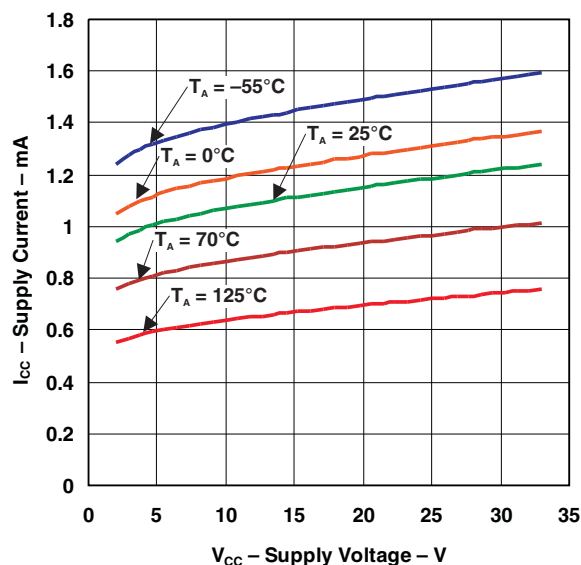
PARAMETER	TEST CONDITIONS		LM2901	UNIT
			TYP	
Response time	R_L connected to 5 V through 5.1 k Ω , $C_L = 15\text{ pF}^{(1)(2)}$	100-mV input step with 5-mV overdrive	1.3	μs
		TTL-level input step	0.3	

(1) C_L includes probe and jig capacitance.

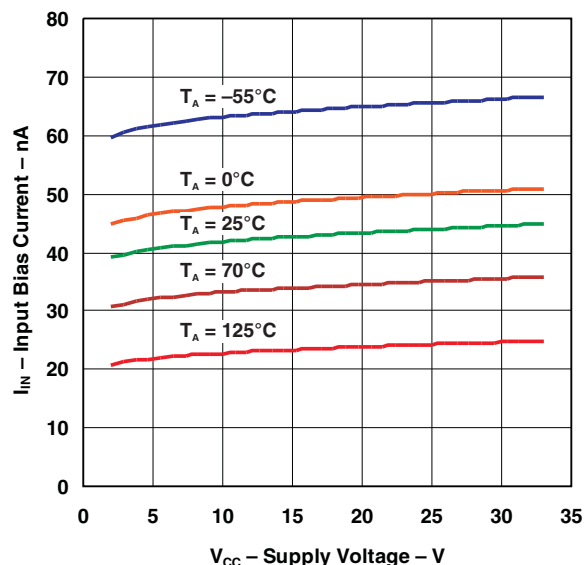
(2) The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

TYPICAL CHARACTERISTICS

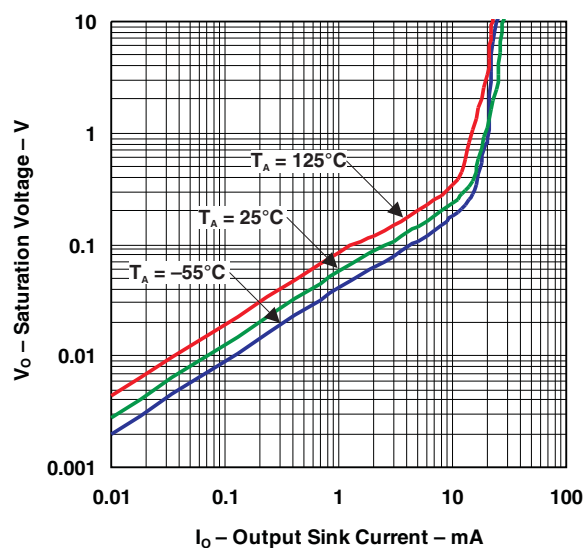
SUPPLY CURRENT
vs
SUPPLY VOLTAGE



INPUT BIAS CURRENT
vs
SUPPLY VOLTAGE

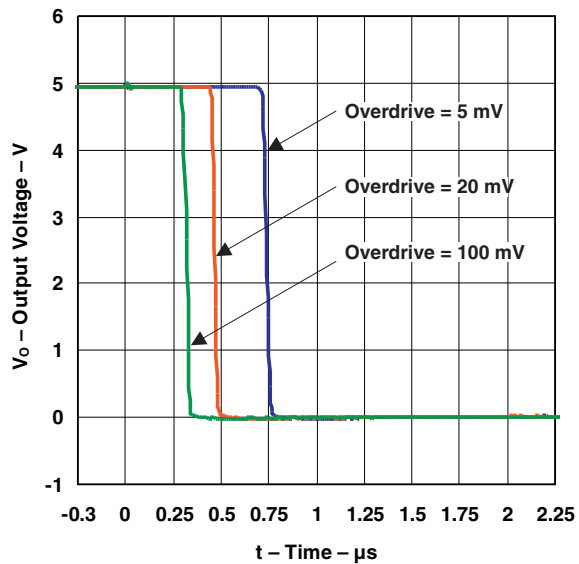


OUTPUT SATURATION VOLTAGE

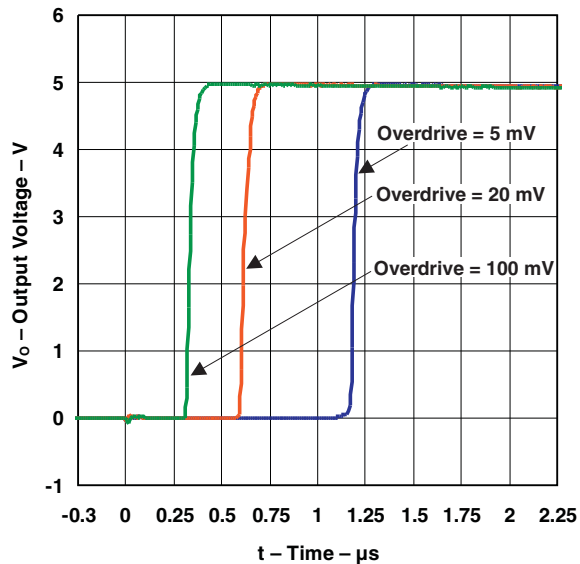


TYPICAL CHARACTERISTICS (continued)

RESPONSE TIME FOR VARIOUS OVERDRIVES
NEGATIVE TRANSITION



RESPONSE TIME FOR VARIOUS OVERDRIVES
POSITIVE TRANSITION



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-7700801VCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
5962-87739012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-8773901CA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
5962-8773901DA	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
77008012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
7700801CA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
7700801DA	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/11201BCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139AD	ACTIVE	SOIC	D	14	50	TBD	CU NIPDAU	Level-3-245C-168 HR
LM139ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM139ADR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM139ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM139AFKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
LM139AJ	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139AJB	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
LM139AW	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139AWB	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139D	ACTIVE	SOIC	D	14	50	TBD	CU NIPDAU	Level-1-220C-UNLIM
LM139DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM139DR	ACTIVE	SOIC	D	14	2500	TBD	CU NIPDAU	Level-1-220C-UNLIM
LM139DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM139FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
LM139FKB	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
LM139J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139JB	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
LM139W	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM139WB	ACTIVE	CFP	W	14	1	TBD	A42 SNPB	N / A for Pkg Type
LM239AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
LM239AN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
LM239D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM239NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM239PW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239PWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM239PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901AVQDR	NRND	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2901AVQDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901AVQPWR	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
LM2901AVQPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM2901NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM2901NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901PW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901PWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901PWLE	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI
LM2901PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901QD	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
LM2901QN	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
LM2901VQDR	NRND	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2901VQDRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM2901VQPWR	ACTIVE	TSSOP	PW	14	2000	TBD	CU NIPDAU	Level-1-250C-UNLIM
LM2901VQPWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339ADBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339ADBRG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM339ANE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM339ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
LM339ANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339APW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339APWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339APWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339APWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339APWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339APWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DBLE	OBSOLETE	SSOP	DB	14		TBD	Call TI	Call TI
LM339DBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DBRG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339DRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM339NE4	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
LM339NSLE	OBSOLETE	SO	NS	14		TBD	Call TI	Call TI
LM339NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339NSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339PW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339PWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339PWG4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339PWLE	OBSOLETE	TSSOP	PW	14		TBD	Call TI	Call TI
LM339PWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
LM339PWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339PWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LM339Y	OBSOLETE			0		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

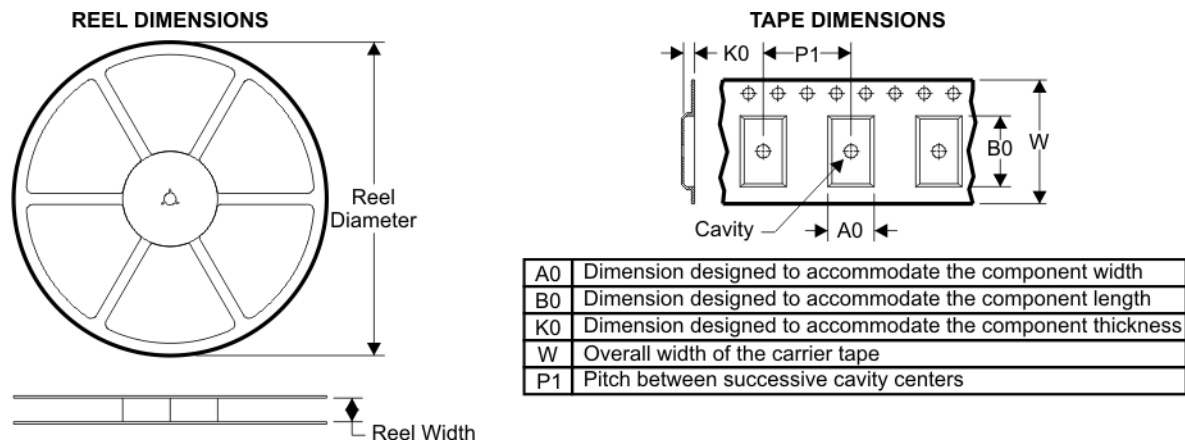
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

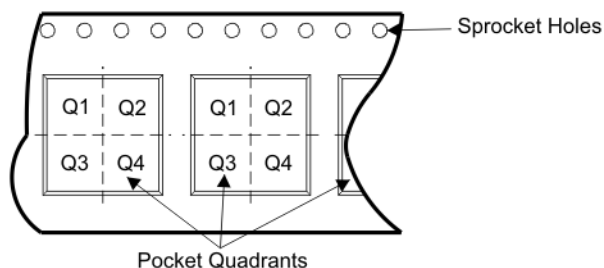
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TAPE AND REEL BOX INFORMATION

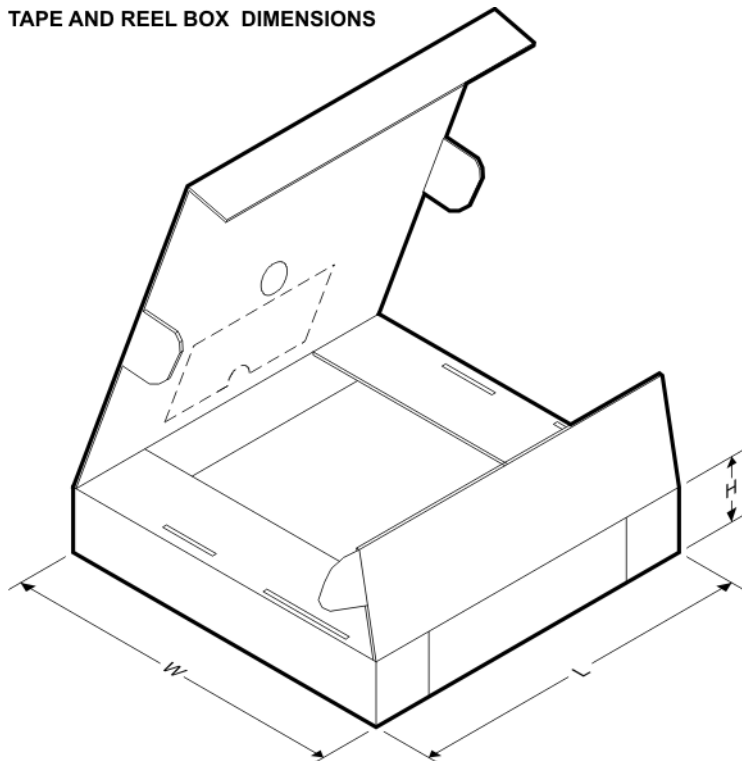


QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package	Pins	Site	Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM239ADR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
LM239ADR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM239DR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
LM239DR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM239PWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM2901DR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
LM2901DR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM2901NSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM2901PWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM339ADBR	DB	14	SITE 41	330	16	8.2	6.6	2.5	12	16	Q1
LM339ADR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
LM339ADR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM339ANSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM339APWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
LM339DBR	DB	14	SITE 41	330	16	8.2	6.6	2.5	12	16	Q1
LM339DR	D	14	SITE 27	330	16	6.5	9.0	2.1	8	16	Q1
LM339DR	D	14	SITE 41	330	16	6.5	9.0	2.1	8	16	Q1
LM339NSR	NS	14	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
LM339PWR	PW	14	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1

TAPE AND REEL BOX DIMENSIONS



Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
LM239ADR	D	14	SITE 27	342.9	336.6	28.58
LM239ADR	D	14	SITE 41	346.0	346.0	33.0
LM239DR	D	14	SITE 27	342.9	336.6	28.58
LM239DR	D	14	SITE 41	346.0	346.0	33.0
LM239PWR	PW	14	SITE 41	346.0	346.0	29.0
LM2901DR	D	14	SITE 27	342.9	336.6	28.58
LM2901DR	D	14	SITE 41	346.0	346.0	33.0
LM2901NSR	NS	14	SITE 41	346.0	346.0	33.0
LM2901PWR	PW	14	SITE 41	346.0	346.0	29.0
LM339ADBR	DB	14	SITE 41	346.0	346.0	33.0
LM339ADR	D	14	SITE 27	342.9	336.6	28.58
LM339ADR	D	14	SITE 41	346.0	346.0	33.0
LM339ANSR	NS	14	SITE 41	346.0	346.0	33.0
LM339APWR	PW	14	SITE 41	346.0	346.0	29.0
LM339DBR	DB	14	SITE 41	346.0	346.0	33.0
LM339DR	D	14	SITE 27	342.9	336.6	28.58
LM339DR	D	14	SITE 41	346.0	346.0	33.0
LM339NSR	NS	14	SITE 41	346.0	346.0	33.0
LM339PWR	PW	14	SITE 41	346.0	346.0	29.0

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

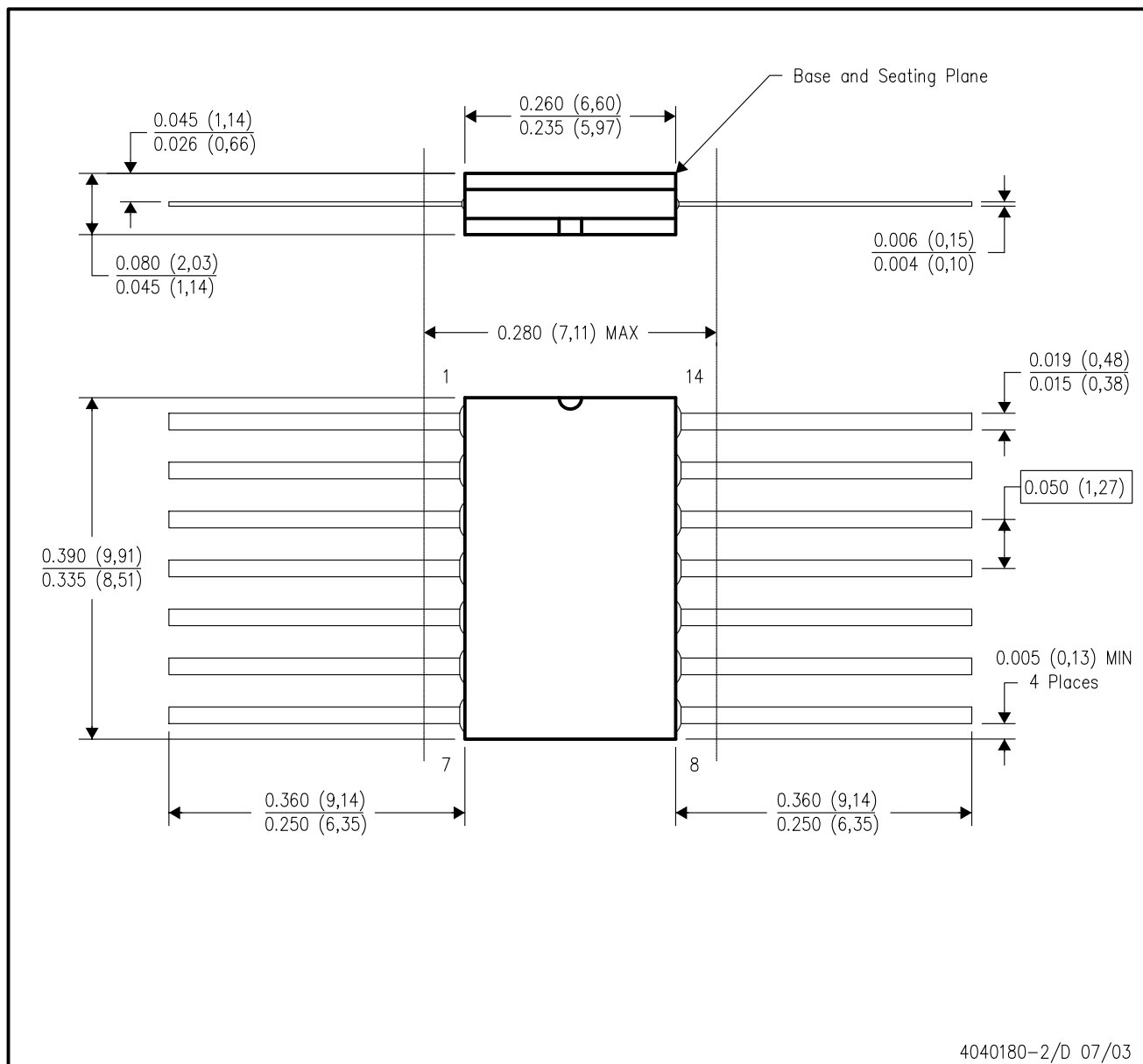


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK

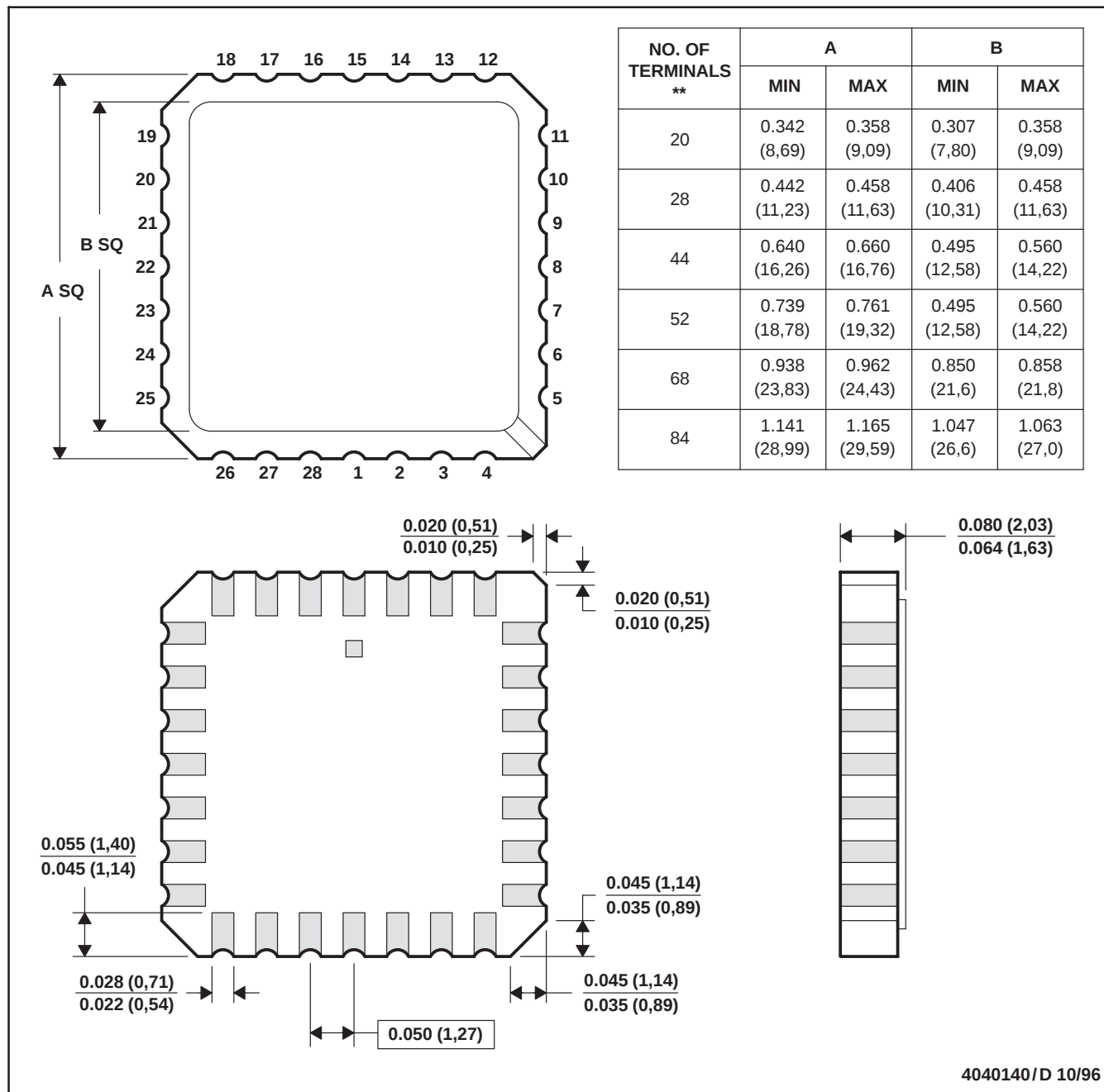


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - The terminals are gold plated.
 - Falls within JEDEC MS-004

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



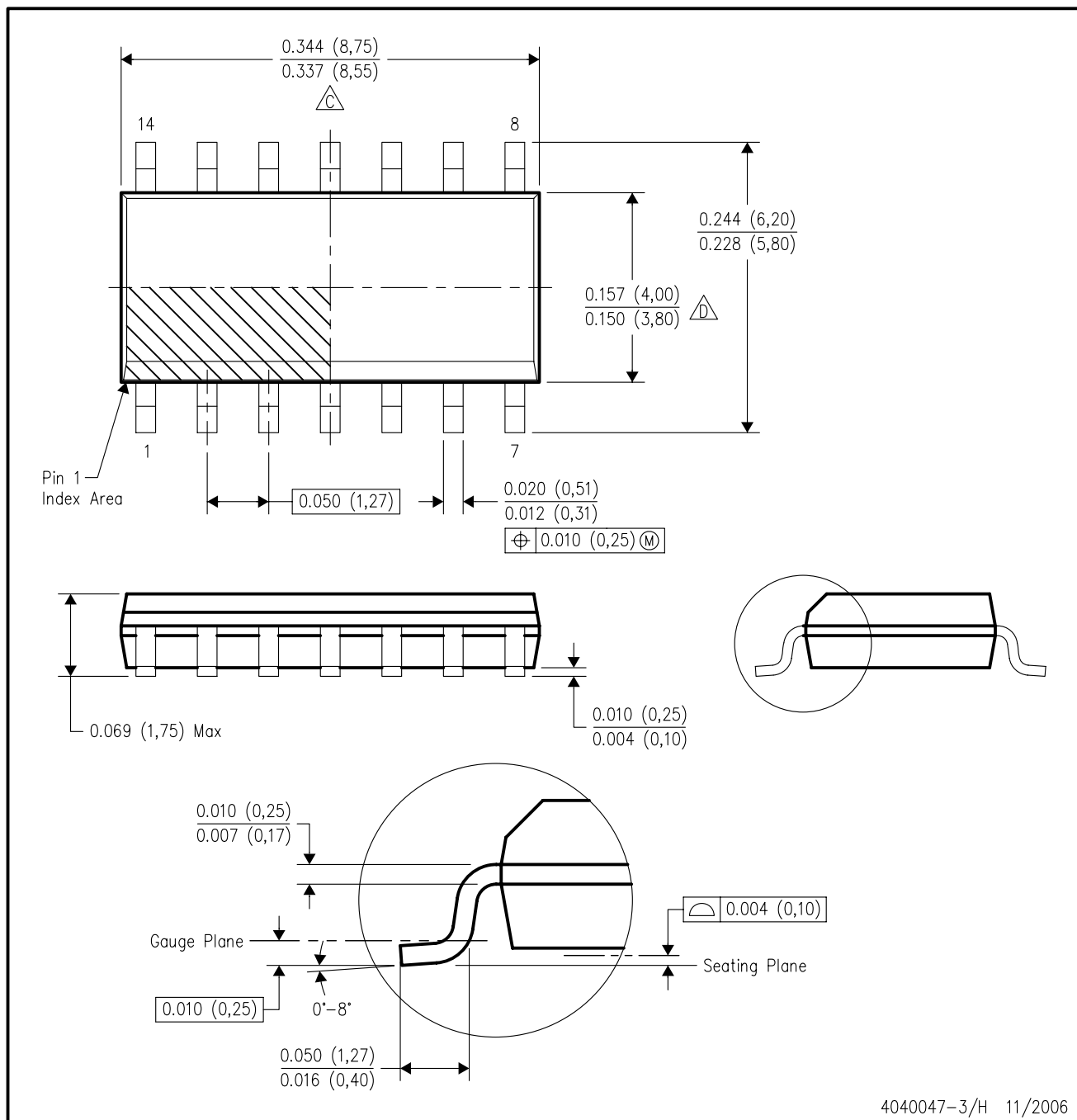
4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



4040047-3/H 11/2006

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

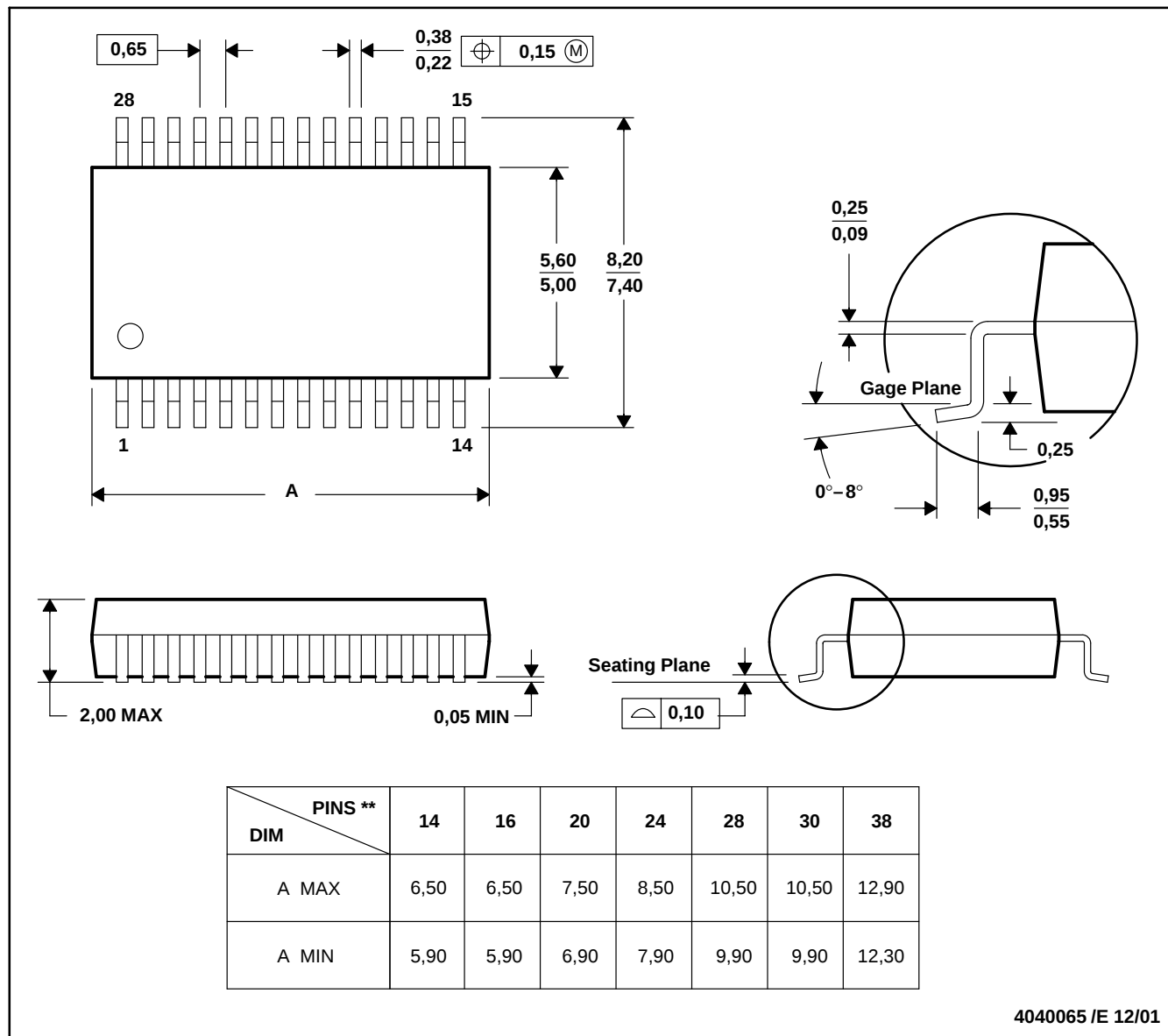


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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